

## NCE N-Channel Super Trench Power MOSFET

#### Description

The NCEP3065BQU uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

#### **General Features**

• V<sub>DS</sub> =30V,I<sub>D</sub> =65A

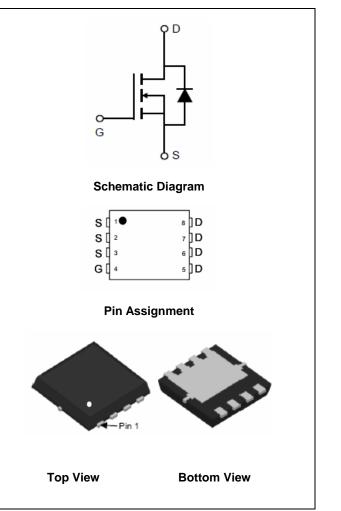
 $\begin{aligned} R_{DS(ON)} = 1.75 m \Omega \text{ (typical)} @ V_{GS} = 10V \\ R_{DS(ON)} = 2.0 m \Omega \text{ (typical)} @ V_{GS} = 4.5V \\ R_{DS(ON)} = 2.6 m \Omega \text{ (typical)} @ V_{GS} = 2.5V \end{aligned}$ 

- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

#### Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

#### 100% UIS TESTED! 100% ΔVds TESTED!



#### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP3065BQU	NCEP3065BQU	DFN3.3X3.3-8L	-	-	-

#### Absolute Maximum Ratings (T<sub>c</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	30	V	
Gate-Source Voltage	Vgs	±12	V	
Drain Current-Continuous	I <sub>D</sub>	65	A	
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃)	45.5	А	
Pulsed Drain Current <sup>(Note 1)</sup>	I <sub>DM</sub>	260	A	
Maximum Power Dissipation	PD	55	W	
Derating factor		0.44	W/℃	
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	260	mJ	
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	°C	
Thermal Characteristic				
Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>θJC</sub>	2.3	°C/W	



#### Electrical Characteristics (T<sub>c</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	· · ·					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	30		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =30V, $V_{GS}$ =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±12V, $V_{DS}$ =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	0.45	-	1.0	V
	R <sub>DS(ON)</sub>	$V_{GS}$ =10V, I <sub>D</sub> =20A	-	1.75	1.95	mΩ
Drain-Source On-State Resistance		V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A	-	2.0	2.3	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =20A	-	2.6	3.1	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =20A		60	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	V <sub>DS</sub> =15V,V <sub>GS</sub> =0V,	-	3115	-	PF
Output Capacitance	C <sub>oss</sub>		-	928	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz	-	37	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	10	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =15V,I <sub>D</sub> =20A	-	5	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{G}$ =1.6 $\Omega$	-	45	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	9.5	-	nS
Total Gate Charge	Qg		-	30.4	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =15V,I <sub>D</sub> =20A,	-	3.1		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =4.5V	-	5.1		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-		1.2	V
Diode Forward Current (Note 2)	I <sub>S</sub>		-	-	65	А
Reverse Recovery Time	t <sub>rr</sub>	$T_J$ = 25°C, $I_F$ = $I_S$	-	18	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	26	-	nC

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

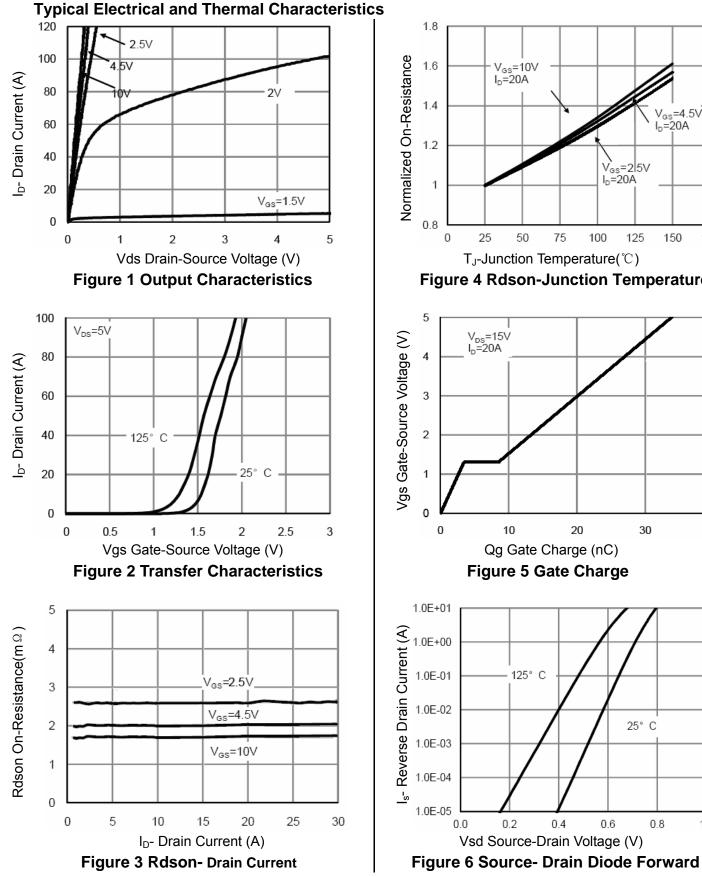
2. Surface Mounted on FR4 Board,  $t \le 10$  sec.

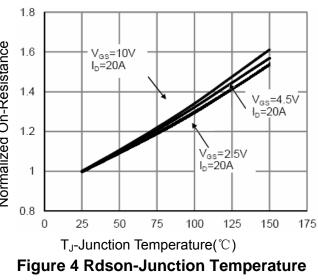
3. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

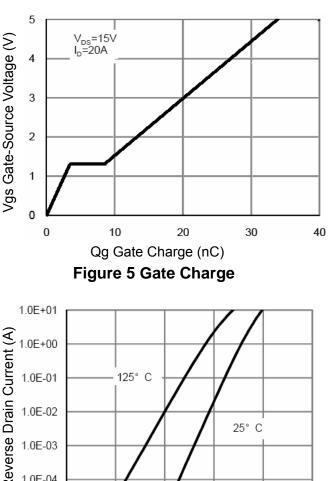
4. Guaranteed by design, not subject to production

5. EAS condition : Tj=25  $^\circ C$  ,V\_DD=15V,V\_G=10V,L=0.5mH,Rg=25\Omega









0.2

0.4

Vsd Source-Drain Voltage (V)

0.6

0.8

1.0



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# NCEP3065BQU

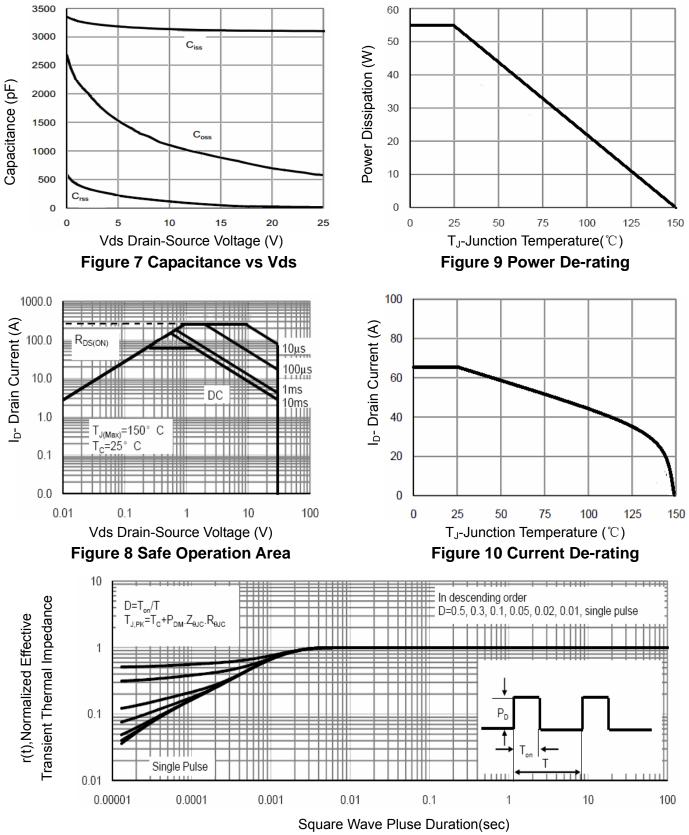
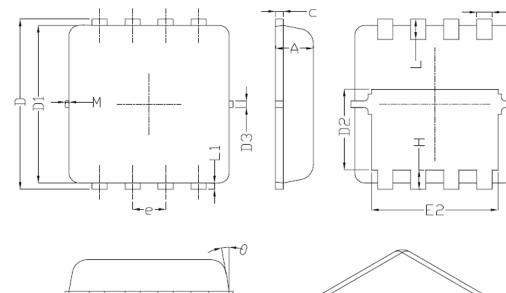
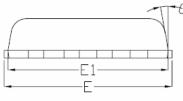


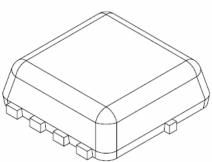
Figure 11 Normalized Maximum Transient Thermal Impedance



### DFN3.3X3.3-8L Package Information







Symbol	Dimensions In Millimeters				
Symbol	Min.	Nom.	Max.		
A	0.70	0.75	0.80		
b	0.25	0.30	0.35		
с	0.10	0.15	0.25		
D	3.25	3.35	3.45		
D1	3.00	3.10	3.20		
D2	1.48	1.58	1.68		
D3	-	0.13	-		
E	3.20	3.30	3.40		
E1	3.00	3.15	3.20		
E2	2.39	2.49	2.59		
e	0.65BSC				
Н	0.30	0.39	0.50		
L	0.30	0.40	0.50		
L1	-	0.13	-		
М	*	*	0.15		
θ		10 <sup>°</sup>	12 <sup>°</sup>		



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